

## Using heatsink mount power resistors

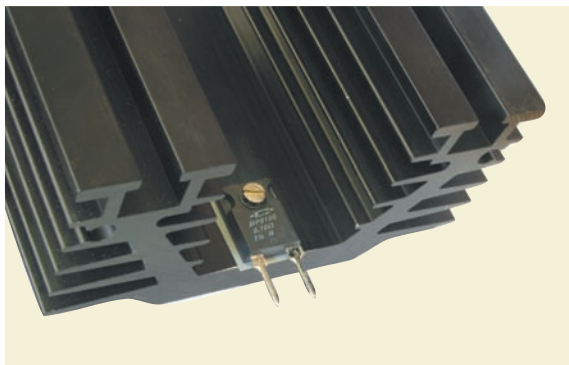
Heatsink mounted power resistors offer the designer several advantages over using conventional (non- heatsink mounted) power resistors.

These are:

- Low inductance compared to power wirewound resistors.
- As the parts are attached to a heatsink there is a reduced susceptibility to vibration.
- Good thermal management leading to reduced heating effects on neighbouring components.
- Space saving on PCB.

### Working out thermal requirements for MP series power resistors.

The maximum power rating is specified with the ceramic back surface maintained at 25°C. Careful design and testing is needed to make sure the case temperature does not exceed its rating.



The allowable power rating ( $P_d$ , Watts) may be determined as follows:

$$P_d = (T_J - T_A) / (R_{\theta_{JC}} + R_{\theta_{CS}} + R_{\theta_{SA}})$$

Where:

$T_J$  is the maximum temperature for the resistance film. 150°C for MP930, MP915, MP925 and 175°C for the MP9100.

$T_A$  is the ambient or temperature reference.

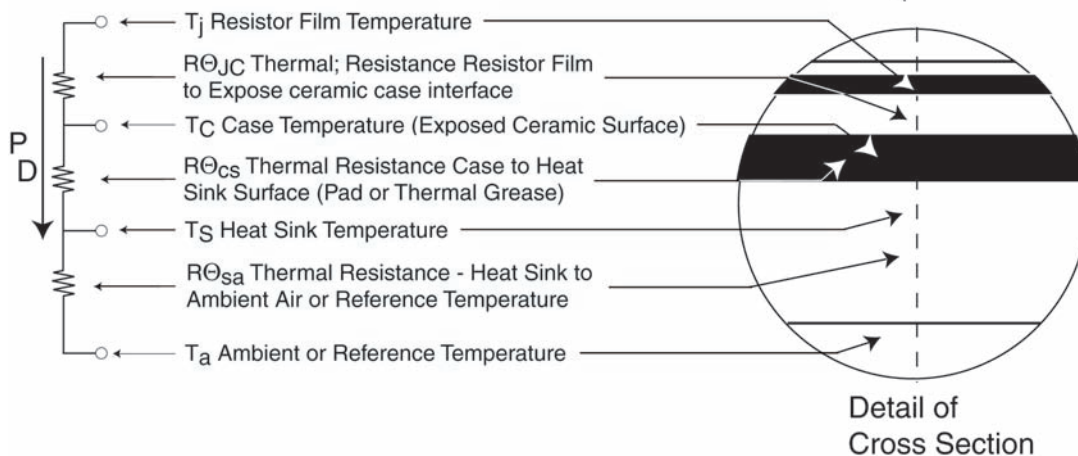
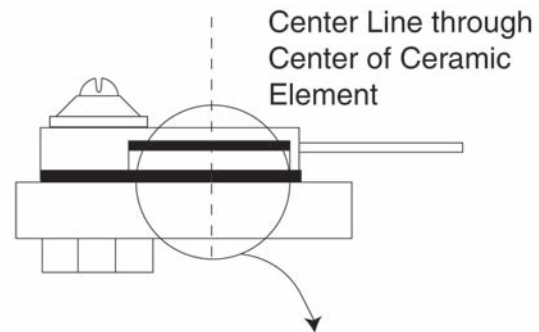
$R_{\theta_{JC}}$  Is the thermal resistance-resistor film to ceramic element

$R_{\theta_{CS}}$  Is the thermal resistance-ceramic element to heatsink surface (pad or thermal grease)\*

$R_{\theta_{SA}}$  Is the thermal resistance of heatsink to ambient.

\* The use of thermal grease or thermal pads is strongly recommended, typically the thermal resistance can vary between 0.5 to 2°C/W.

$R_{\theta_{JC}} = 8.3^\circ\text{C/W}$  (MP915),  $5^\circ\text{C/W}$  (MP925),  $4.17^\circ\text{C/W}$  (MP930),  $1.5^\circ\text{C/W}$  (MP9100).



## Using heatsink mount power resistors (continued)

### Selecting a heat sink for a MP series power resistor

$$R\theta_{CS} + R\theta_{SA} = ((T_J - T_A) / Pd) - R\theta_{JC}$$

Using the MP930 series at an ambient temperature of 25°C with a power dissipation of 8 Watts, the total allowable thermal resistance for the heat sink and the attachment interface is as follows:

$$\text{Maximum total } R\theta \text{ of the heat sink and interface} = ((150^\circ\text{C} - 25^\circ\text{C}) / 8\text{W}) - 4.17^\circ\text{C/W}$$

$$((150^\circ\text{C} - 25^\circ\text{C}) / 8\text{W}) - 4.17^\circ\text{C/W} = 15.63^\circ\text{C/W} - 4.17^\circ\text{C/W} = 11.46^\circ\text{C/W}$$

If 1°C per watt is allowed for the interface, then a heatsink of approximately 10.5°C/W is required.

### Determining the maximum power of a MP series power resistor for a given heatsink

For a MP9100 used on a 40°C ambient heatsink with a thermal resistance of 5°C/W, the maximum power dissipation is determined as follows (assuming 1°C/W for thermal grease):

$$Pd = (T_J - T_A) / (R\theta_{JC} + R\theta_{CS} + R\theta_{SA})$$

$$Pd = (175^\circ\text{C} - 40^\circ\text{C}) / (1.5 + 1 + 5)$$

$$Pd = 135 / 7.5 = 18\text{W}$$